# Flexible Hybrid Electronics for Extreme Environment (FEEE)

Chiplet-based flexible electronics platform survives radiation, vibration, and thermal cycling.

Extreme environments pose intense and dynamic conditions, particularly to electronic systems which are sensitive to temperature, humidity, radiation, and more. Despite the prevalence of extreme conditions across a variety of industries and applications, there have been no demonstrations of flexible electronics platforms capable of withstanding these conditions. Researchers at Purdue University have developed a platform-based approach to creating flexible electronics for extreme environments. Purdue's platform includes use of a flexible substrate and chiplets capable of withstanding extreme thermal cycle, arctic environment, high vibration, high/low G, high UV, radiation, EM, humidity, salinity and pH variation. This technology can be used to integrate physically conformable electronics in aerospace, automotive, industrial and defense applications for sensing, autonomy, and more.

#### **Advantages**

- -Flexible substrate and chiplets
- -Use in extreme environments
- -Improved system resilience

### **Applications**

- -Flexible electronics
- -Extreme Environments
- -Aerospace
- -Automotive

### **Technology Validation:**

#### **Technology ID**

2024-HUSS-70548

#### Category

Aerospace & Defense/Defense
Electronics & Surveillance
Technologies
Aerospace &
Defense/Hypersonics &
Propulsion Systems
Automotive & Mobility
Tech/Micromobility & Smart
Urban Infrastructure

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#### View online



This technology is in the conceptual stages.

**TRL:** 2

## **Intellectual Property:**

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